

PC901V

Digital Output Type OPIC Photocoupler

■ Features

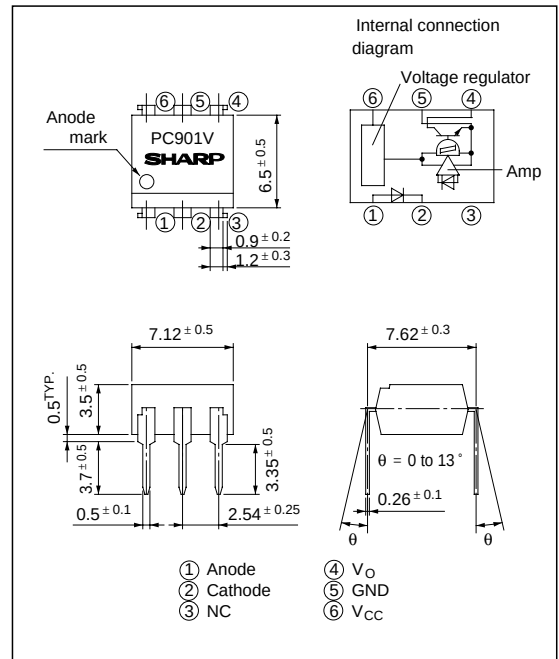
1. Normal-ON operation, open collector output
2. Operating supply voltage (V_{CC} : 3 to 15V)
3. TTL and LSTTL compatible output
4. High isolation voltage between input and output (V_{iso} : 5 000V_{rms})
5. High sensitivity (I_{FLH} : MAX. 2.0mA at $T_a = 25^\circ\text{C}$)
6. Recognized by UL, file No. 64380

■ Applications

1. Isolation between logic circuits
2. Logic level shifters
3. Line receivers
4. Replacements for relays and pulse transformers
5. Noise reduction

■ Outline Dimensions

(Unit : mm)



* “ OPIC ” (Optical IC) is a trademark of the SHARP Corporation.

An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	*1 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
Output	Supply voltage	V_{CC}	16	V
	High level output voltage	V_{OH}	16	V
	Low level output current	I_{OL}	50	mA
	Power dissipation	P_O	150	mW
	Total power dissipation	P_{tot}	170	mW
	*2 Isolation voltage	V_{iso}	5 000	V _{rms}
Operating temperature		T_{opr}	- 25 to + 85	$^\circ\text{C}$
Storage temperature		T_{stg}	- 40 to + 125	$^\circ\text{C}$
*3 Soldering temperature		T_{sol}	260	$^\circ\text{C}$

*1 Pulse width $\leq 100\mu\text{s}$, Duty ratio : 0.001

*2 40 to 60% RH, AC for 1 minute

*3 For 10 seconds

■ Electro-optical Characteristics

(Ta = 0 to + 70°C unless otherwise specified)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F = 4mA	-	1.1	1.4	V	
			I _F = 0.3mA	0.7	1.0	-		
	Reverse current	I _R	Ta = 25°C, V _R = 4V	-	-	10	μA	
	Terminal capacitance	C _t	Ta = 25°C, V = 0, f = 1kHz	-	30	250	pF	
Output	Operating supply voltage	V _{CC}		3	-	15	V	
	Low level output voltage	V _{OL}	I _{OL} = 16mA, V _{CC} = 5V, I _F = 4mA	-	0.2	0.4	V	
	High level output current	I _{OH}	V _O = V _{CC} = 15V, I _F = 0	-	-	100	μA	
	Low level supply current	I _{CCL}	V _{CC} = 5V, I _F = 0	-	2.5	5.0	mA	
	High level supply current	I _{CCH}	V _{CC} = 5V, I _F = 4mA	-	2.7	5.5	mA	
Transfer characteristics	*4 “L→H” threshold input current	I _{FLH}	Ta = 25°C, V _{CC} = 5V, R _L = 280Ω	-	1.1	2.0	mA	
			V _{CC} = 5V, R _L = 280Ω	-	-	4.0		
	*5 “H→L” threshold input current	I _{FHL}	Ta = 25°C, V _{CC} = 5V, R _L = 280Ω	0.4	0.8	-	mA	
			V _{CC} = 5V, R _L = 280Ω	0.3	-	-		
	*6 Hysteresis	I _{FHL} / I _{FLH}	V _{CC} = 5V, R _L = 280Ω	0.5	0.7	0.9	-	
	Isolation resistance		R _{ISO}	Ta = 25°C, DC500V, 40 to 60% RH	5 x 10 ¹⁰	10 ¹¹	-	Ω
	*7Response time	“L→H” propagation delay time	t _{PLH}	Ta = 25°C V _{CC} = 5V, I _F = 4mA R _L = 280Ω	-	1	3	μs
		“H→L” propagation delay time	t _{PHL}		-	2	6	
		Rise time	t _r		-	0.1	0.5	
		Fall time	t _f		-	0.05	0.5	
	*8Instantaneous common mode rejection voltage (High level output)		CM _H	V _{CM} = 600V (peak), V _O (MIN.) = 2V I _F = 4mA, R _L = 280Ω, Ta = 25°C	-	- 2000	-	V/ μs
	*8Instantaneous common mode rejection voltage (Low level output)		CM _L	V _{CM} = 600V (peak), V _O (MAX.) = 0.8V I _F = 0, R _L = 280Ω, Ta = 25°C	-	2000	-	V/ μs

*4 I_{FLH} represents forward current when output goes from low to high.

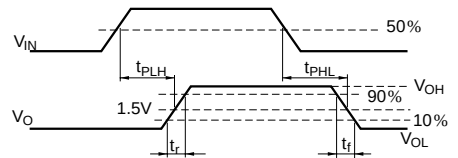
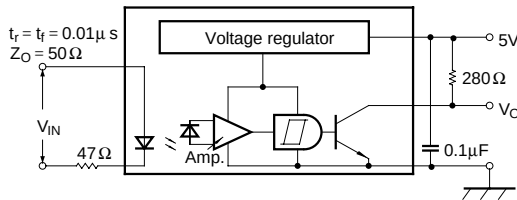
*5 I_{FHL} represents forward current when output goes from high to low.

*6 Hysteresis stands for I_{FHL} / I_{FLH}

*7 Test circuit for response time is shown below.

*8 Test circuit for CM_H, CM_L shown below.

Test Circuit for Response Time



Test Circuit for CM_H, CM_L

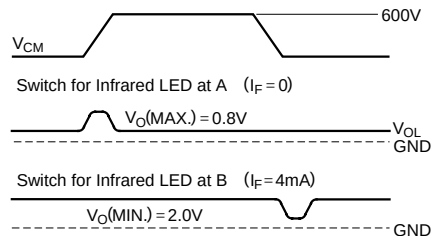
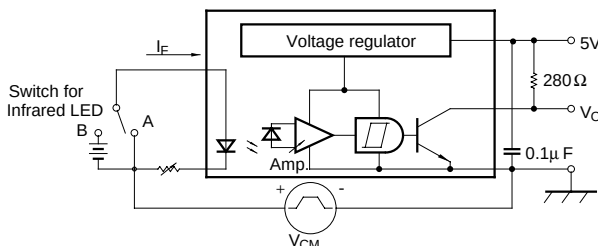


Fig. 1 Forward Current vs. Ambient Temperature

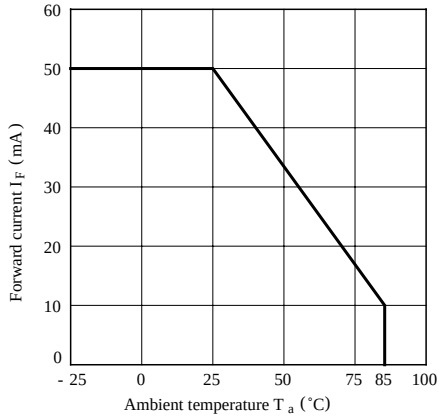


Fig. 2 Power Dissipation vs. Ambient Temperature

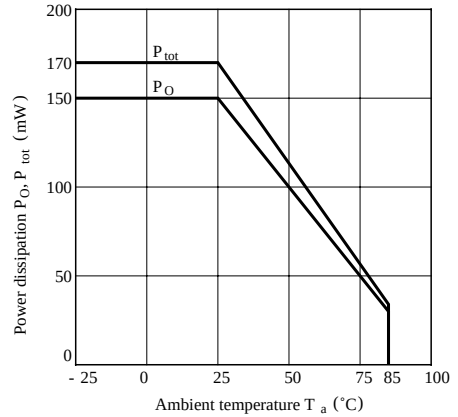


Fig. 3 Forward Current vs. Forward Voltage

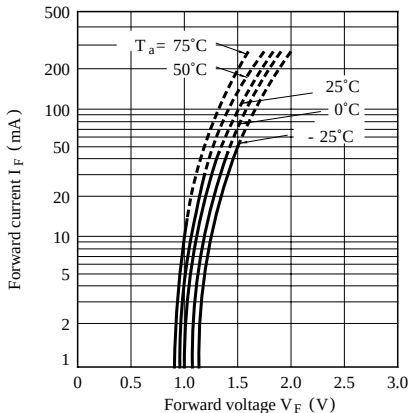


Fig. 4 Relative Threshold Input Current vs. Supply Voltage

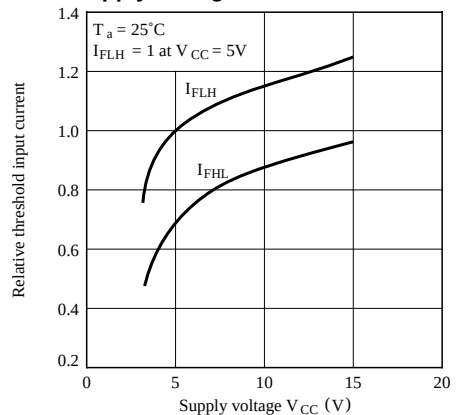


Fig. 5 Relative Threshold Input Current vs. Ambient Temperature

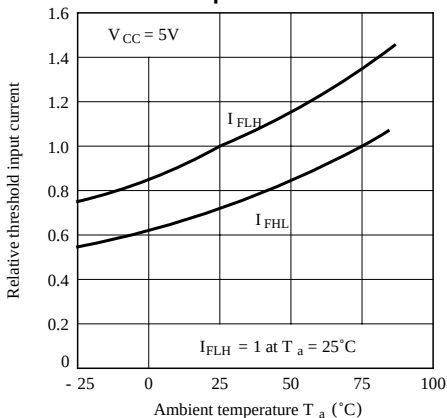


Fig. 6 Low Level Output Voltage vs. Low Level Output Current

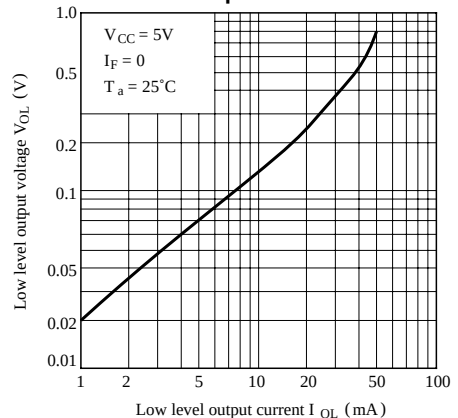


Fig. 7 Low Level Output Voltage vs. Ambient Temperature

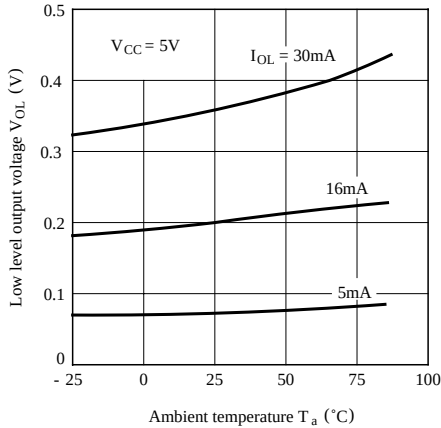


Fig. 8 High Level Output Current vs. Forward Current

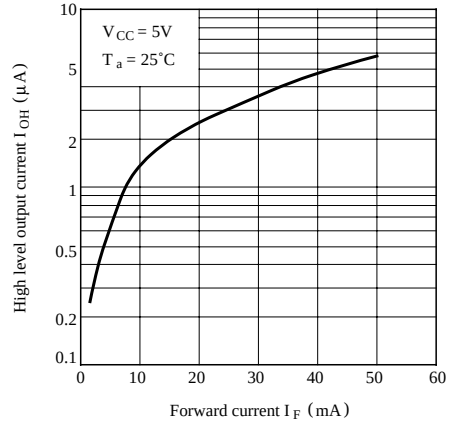


Fig. 9 High Level Output Current vs. Ambient Temperature

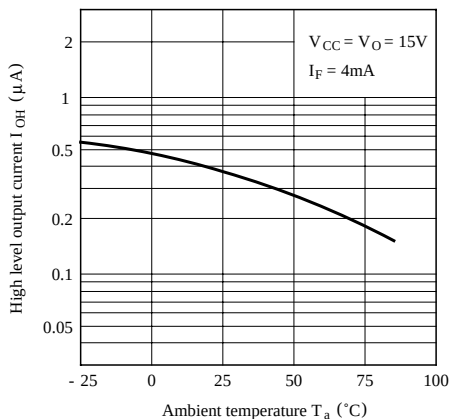


Fig.10 Supply Current vs. Supply Voltage

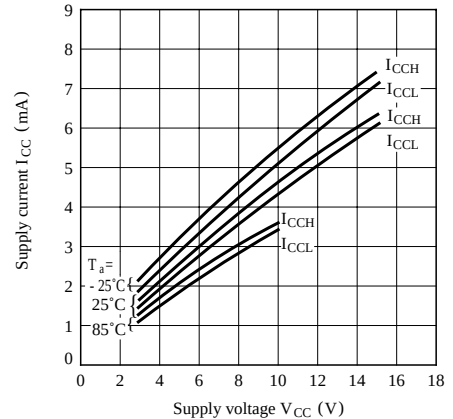


Fig.11 Propagation Delay Time vs. Forward Current

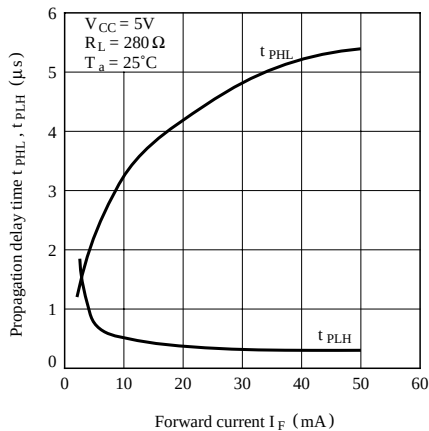


Fig.12 Rise Time, Fall Time vs. Load Resistance

